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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







BTS 5234L

Smart High-Side Power Switch PROFET Two Channels, 60 m Ω

Automotive Power





Smart High-Side Power Switch BTS 5234L

Table o	f Contents Pa	age
Produc	t Summary	3
1.1 B	view lock Diagram	5
2.1 P	onfiguration in Assignment BTS 5234L	7
	rical Characteristics	
4.1 P 4.1. 4.1. 4.1. 4.2 P 4.2. 4.2. 4.2. 4.2.	2 Input Circuit 3 Inductive Output Clamp 4 Electrical Characteristics rotection Functions 1 Over Load Protection 2 Reverse Polarity Protection 3 Over Voltage Protection 4 Loss of Ground Protection 5 Electrical Characteristics hiagnosis 1 ON-State Diagnosis 2 OFF-State Diagnosis 3 Sense Enable Function	.10 10 10 11 13 .15 16 16 17 .18 19 20 21
5 Packa	age Outlines BTS 5234L	.24
6 Revis	sion History	.25



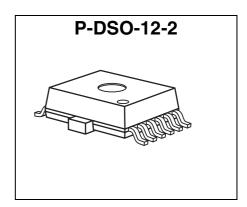
Smart High-Side Power Switch PROFET

BTS 5234L

Product Summary

The BTS 5234L is a dual channel high-side power switch in P-DSO-12-2 package providing embedded protective functions.

The power transistor is built by a N-channel vertical power MOSFET with charge pump. The device is monolithically integrated in Smart SIPMOS technology.



Operating voltage	$V_{bb(on)}$	4.5 28 V
Over voltage protection	$V_{bb(AZ)}$	41 V
On-State resistance	R _{DS(ON)}	60 mΩ
Nominal load current (one channel active)	$I_{L(nom)}$	3.5 A
Current limitation	$I_{L(LIM)}$	23 A
Current limitation repetitive	$I_{L(SCr)}$	6 A
Standby current for whole device with load	I _{bb(OFF)}	2.5 μΑ

Basic Features

- Very low standby current
- 3.3 V and 5 V compatible logic pins
- Improved electromagnetic compatibility (EMC)
- Stable behavior at under voltage
- · Logic ground independent from load ground
- · Secure load turn-off while logic ground disconnected
- · Optimized inverse current capability

Туре	Ordering Code	Package		
BTS 5234L	Q67060-S6155	P-DSO-12-2		

Data Sheet 3 V1.0, 2004-01-23



Protective Functions

- Reverse battery protection without external components
- Short circuit protection
- Overload protection
- Multi-step current limitation
- Thermal shutdown with restart
- Thermal restart at reduced current limitation
- Over voltage protection without external resistor
- Loss of ground protection
- Electrostatic discharge protection (ESD)

Diagnostic Functions

- Enhanced IntelliSense signal for each channel
- Enable function for diagnosis pins (IS1 and IS2)
- Proportional load current sense signal by current source
- High accuracy of current sense signal at wide load current range
- Open load detection in ON-state by load current sense
- Open load detection in OFF-state by voltage source
- Feedback on over temperature and current limitation in ON-state

Applications

- µC compatible high-side power switch with diagnostic feedback for 12 V grounded loads
- All types of resistive, inductive and capacitive loads
- Suitable for loads with high inrush currents, so as lamps
- Suitable for loads with low currents, so as LEDs
- Replaces electromechanical relays, fuses and discrete circuits

Data Sheet 4 V1.0, 2004-01-23



Overview

1 Overview

The BTS 5234L is a dual channel high-side power switch (two times 60 m Ω) in P-DSO-12-2 power package providing embedded protective functions.

The Enhanced IntelliSense pins IS1 and IS2 provide a sophisticated diagnostic feedback signal including current sense function and open load in off state. The diagnosis signals can be switched on and off by the sense enable pin SEN.

An integrated ground resistor as well as integrated resistors at each input pin (IN1, IN2, SEN) reduce external components to a minimum.

The power transistor is built by a N-channel vertical power MOSFET with charge pump. The inputs are ground referenced CMOS compatible. The device is monolithically integrated in Smart SIPMOS technology.

1.1 Block Diagram

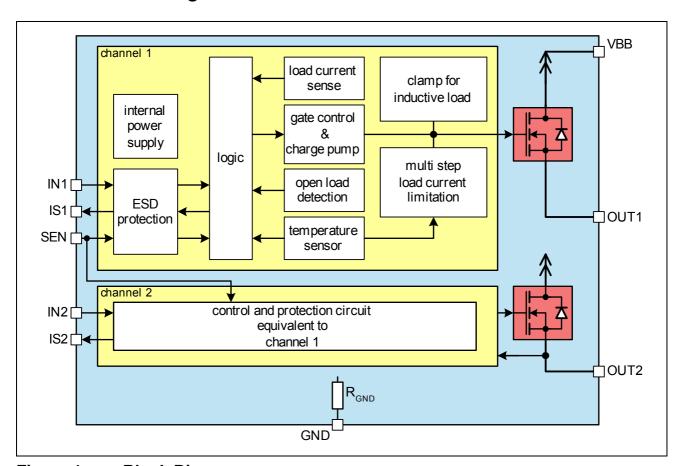


Figure 1 Block Diagram

Data Sheet 5 V1.0, 2004-01-23



Overview

1.2 Terms

Following figure shows all terms used in this data sheet.

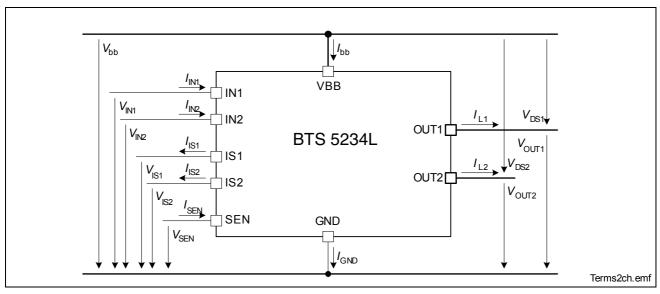


Figure 2 Terms



Pin Configuration

2 Pin Configuration

2.1 Pin Assignment BTS 5234L

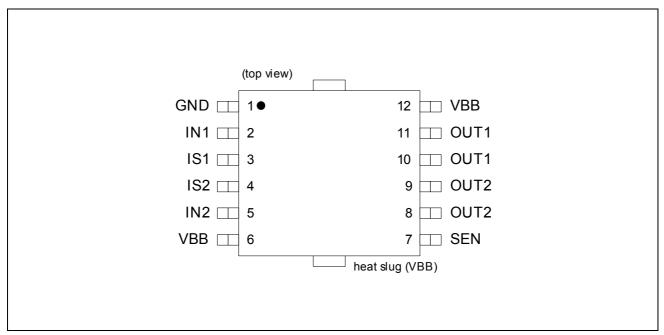


Figure 3 Pin Configuration P-DSO-12-2

2.2 Pin Definitions and Functions

Pin	Symbol	I/O OD	Function
2	IN1	I	Input signal for channel 1
5	IN2	I	Input signal for channel 2
3	IS1	0	Diagnosis output signal channel 1
4	IS2	0	Diagnosis output signal channel 2
7	SEN	I	Sense Enable input for channel 1&2
10,11	OUT1	0	Protected high-side power output channel 1
8, 9	OUT2	0	Protected high-side power output channel 2
1	GND	-	Ground connection
6,12, heat slug	VBB	-	Positive power supply for logic supply as well as output power supply

Data Sheet 7 V1.0, 2004-01-23



Electrical Characteristics

3 Electrical Characteristics

3.1 Maximum Ratings

Stresses above the ones listed here may affect device reliability or may cause permanent damage to the device.

Unless otherwise specified:

$$T_{\rm i}$$
 = 25 °C

Pos.	Parameter	Symbol	Limit	Values	Unit	Test
			min.	max.	=	Conditions
Supply	v Voltage					
3.1.1	Supply voltage	V_{bb}	-16	28	V	
3.1.2	Supply voltage for full short circuit protection (single pulse) $(T_{j(0)} = -40^{\circ}\text{C} 150^{\circ}\text{C})$	V _{bb(SC)}	0	28	V	$L = 8 \mu H,$ $R = 0.2 \Omega^{-1}$
3.1.3	Voltage at power transistor	V_{DS}	-	52	٧	
3.1.4	Supply Voltage for Load Dump protection	$V_{bb(LD)}$		41	V	$R_{\rm l} = 2 \Omega^{2)}$ $R_{\rm L} = 6.8 \Omega$
Power	Stages					
3.1.5	Load current	I_{L}	-	$I_{L(LIM)}$	Α	_ 3)
3.1.6	Maximum energy dissipation single pulse	E_{AS}	-	0.65	J	$I_{L(0)} = 2 \text{ A}^{4)}$ $T_{j(0)} = 150^{\circ}\text{C}$
3.1.7	Power dissipation (DC)	P_{tot}	-	1.6	W	$T_{\rm a}$ = 85 °C ⁵⁾ $T_{\rm j} \le$ 150 °C
Logic I	Pins				•	
3.1.8	Voltage at input pin	V_{IN}	-5 -16	10	V	<i>t</i> ≤ 2 min
3.1.9	Current through input pin	I_{IN}	-2.0 -8.0	2.0	mA	<i>t</i> ≤ 2 min
3.1.10	Voltage at sense enable pin	V_{SEN}	-5 -16	10	V	<i>t</i> ≤ 2 min
3.1.11	Current through sense enable pin	I _{SEN}	-2.0 -8.0	2.0	mA	<i>t</i> ≤ 2 min
3.1.12	Current through sense pin	I_{IS}	-25	10	mA	

Data Sheet 8 V1.0, 2004-01-23



Smart High-Side Power Switch BTS 5234L

Electrical Characteristics

Unless otherwise specified:

 $T_{\rm i}$ = 25 °C

Pos.	Parameter	rameter Symbol Limit Values		Values	Unit	Test
			min.	max.		Conditions
Tempe	ratures					
3.1.13	Junction Temperature	T_{j}	-40	150	°C	
3.1.14	Dynamic temperature increase while switching	$\Delta T_{\rm j}$	-	60	°C	
3.1.15	Storage Temperature	T_{stg}	-55	150	°C	
ESD S	usceptibility					
3.1.16	ESD susceptibility HBM IN, SEN IS OUT	V _{ESD}	-1 -2 -4	1 2 4	kV	according to EIA/JESD 22-A 114B

¹⁾ R and L describe the complete circuit impedance including line, contact and generator impedances

Data Sheet 9 V1.0, 2004-01-23

²⁾ Load Dump is specified in ISO 7636, R_I is the internal resistance of the Load Dump pulse generator

³⁾ Current limitation is a protection feature. Operation in current limitation is considered as "outside" normal operating range. Protection features are not designed for continuous repetitive operation.

Pulse shape represents inductive switch off: $I_L(t) = I_L(0) * (1 - t / t_{peak}); 0 < t < t_{peak}$

Device mounted on PCB (50 mm x 50 mm x 1.5mm epoxy, FR4) with 6 cm 2 copper heatsinking area (one layer, 70 μ m thick) for V_{bb} connection. PCB is vertical without blown air.



4 Block Description and Electrical Characteristics

4.1 Power Stages

The power stages are built by a N-channel vertical power MOSFET (DMOS) with charge pump.

4.1.1 Output On-State Resistance

The on-state resistance $R_{\rm DS(ON)}$ depends on the supply voltage as well as the junction temperature $T_{\rm j}$. Figure 4 shows that dependencies for the typical on-state resistance. The behavior in reverse polarity mode is described in **Section 4.2.2**.

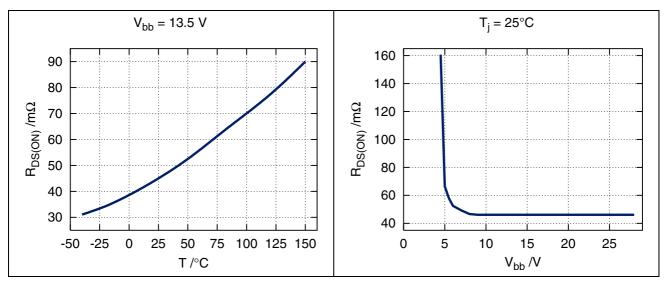


Figure 4 Typical On-State Resistance

4.1.2 Input Circuit

Figure 5 shows the input circuit of the BTS 5234L. There is an integrated input resistor that makes external components obsolete. The current sink to ground ensures that the device switches off in case of open input pin. The zener diode protects the input circuit against ESD pulses.

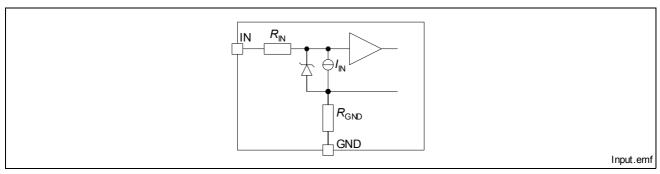


Figure 5 Input Circuit (IN1 and IN2)

Data Sheet 10 V1.0, 2004-01-23



A high signal at the input pin causes the power DMOS to switch on with a dedicated slope, which is optimized in terms of EMC emission.

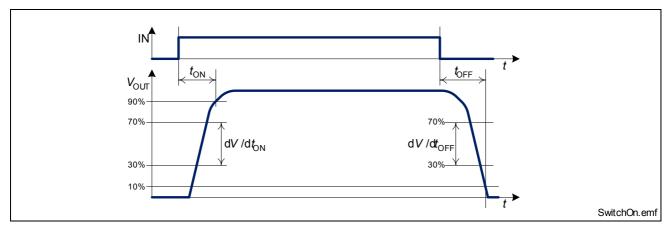


Figure 6 Switching a Load (resistive)

4.1.3 Inductive Output Clamp

When switching off inductive loads with high-side switches, the voltage V_{OUT} drops below ground potential, because the inductance intends to continue driving the current.

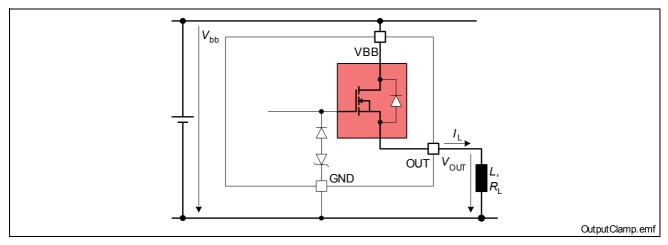


Figure 7 Output Clamp (OUT1 and OUT2)

To prevent destruction of the device, there is a voltage clamp mechanism implemented that keeps that negative output voltage at a certain level $(V_{OUT(CL)})$. See **Figure 7** and **Figure 8** for details. Nevertheless, the maximum allowed load inductance is limited.

Data Sheet 11 V1.0, 2004-01-23



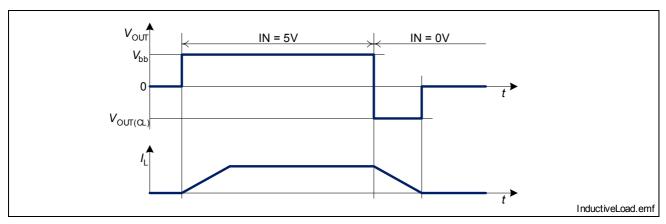


Figure 8 Switching an Inductance

Maximum Load Inductance

While demagnetization of inductive loads, energy has to be dissipated in the BTS 5234L. This energy can be calculated with following equation:

$$E = (V_{\text{bb}} + \left| V_{\text{OUT(CL)}} \right|) \cdot \left\lceil \frac{\left| V_{\text{OUT(CL)}} \right|}{R_{\text{L}}} \cdot \ln \left(1 + \frac{R_{\text{L}} \cdot I_{\text{L}}}{\left| V_{\text{OUT(CL)}} \right|} \right) + I_{\text{L}} \right\rceil \cdot \frac{L}{R_{\text{L}}}$$

Following equation simplifies under the assumption of $R_L = 0$:

$$E = \frac{1}{2}LI_{L}^{2} \cdot \left(1 + \frac{V_{bb}}{|V_{OUT(CL)}|}\right)$$

The energy, which is converted into heat, is limited by the thermal design of the component. See **Figure 9** for the maximum allowed energy dissipation.

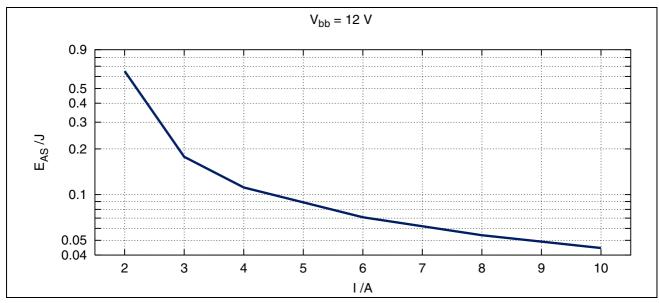


Figure 9 Maximum energy dissipation single pulse, $T_{i,Start} = 150$ °C

Data Sheet 12 V1.0, 2004-01-23



4.1.4 Electrical Characteristics

Unless otherwise specified:

 $V_{
m bb}$ = 9 V to 16 V, $\dot{T}_{
m j}$ = -40 °C to +150 °C, typical values: $V_{
m bb}$ = 13.5 V, $T_{
m j}$ = 25 °C

Pos.	Parameter	Symbol	Lin	Limit Values		Unit	Test Conditions
			min.	typ.	max.		
Gener	al						
4.1.1	Operating voltage	V_{bb}	4.5		28	V	V_{IN} = 4.5 V R_{L} = 12 Ω V_{DS} < 0.5 V
4.1.2	Operating current one channel active all channels active	I_{GND}		1.8 3.6	4 8	mA	V _{IN} = 5 V
4.1.3	Standby current for whole device with load	$I_{ m bb(OFF)}$		1.5	2.5 2.5 15	μΑ	$V_{IN} = 0 \text{ V}$ $V_{SEN} = 0 \text{ V}$ $T_j = 25^{\circ}\text{C}$ $T_j = 85^{\circ}\text{C}^{1)}$ $T_j = 150^{\circ}\text{C}$
Outpu	t characteristics						
4.1.4	On-State resistance per channel	R _{DS(ON)}		45 90	60 115	mΩ	I_{L} = 2.5 A T_{j} = 25 °C T_{i} = 150 °C
4.1.5	Output voltage drop limitation at small load currents	$V_{DS(NL)}$		40		mV	<i>I</i> _L < 0.25 A
4.1.6	Nominal load current per channel one channel active two channels active	I _{L(nom)}	3.5 2.6			A	$T_{\rm a}$ = 85 °C $T_{\rm j} \le$ 150 °C ^{2) 3)}
	ISO load current per channel one channel active two channels active	$I_{L(ISO)}$	5.3 5.3			A	$T_{\rm c}$ = 85 °C $V_{\rm DS}$ = 0.5 V ³⁾
4.1.7	Output clamp	$V_{OUT(CL)}$	-16	-13	-10	V	I_{L} = 40 mA
4.1.8	Output leakage current per channel	$I_{L(OFF)}$		0.1	6	μΑ	$V_{IN} = 0 \; V$
4.1.9	Inverse current capability	-I _{L(inv)}		3		А	1)

Data Sheet 13 V1.0, 2004-01-23



Smart High-Side Power Switch BTS 5234L

Block Description and Electrical Characteristics

Unless otherwise specified:

 $V_{\rm bb}$ = 9 V to 16 V, $T_{\rm j}$ = -40 °C to +150 °C, typical values: $V_{\rm bb}$ = 13.5 V, $T_{\rm j}$ = 25 °C

Pos.	Parameter	Symbol	Limit Values			Unit	Test Conditions
			min.	typ.	max.		
Therm	al Resistance						
4.1.10	Junction to case	$R_{ m thjc}$	-		2.2	K/W	_ 1)
4.1.11	Junction to ambient one channel active all channels active	R _{thja}		45 40		K/W	_ 1)2)
Input o	characteristics						
4.1.12	Input resistor	R_{IN}	1.8	3.5	5.5	kΩ	
4.1.13	L-input level	$V_{IN(L)}$	-0.3		1.0	٧	
4.1.14	H-input level	$V_{IN(H)}$	2.5		5.7	V	
4.1.15	L-input current	$I_{IN(L)}$	3	18	75	μΑ	V_{IN} = 0.4 V
4.1.16	H-input current	$I_{IN(H)}$	10	38	75	μΑ	V_{IN} = 5 V
Timing	js .						
4.1.17	Turn-on time to 90% V _{bb}	t _{ON}		100	250	μs	$R_{\rm L}$ = 12 Ω $V_{\rm bb}$ = 13.5 V
4.1.18	Turn-off time to 10% V _{bb}	t _{OFF}		120	250	μs	$R_{\rm L}$ = 12 Ω $V_{\rm bb}$ = 13.5 V
4.1.19	slew rate 30% to 70% V _{bb}	dV/dt_{ON}	0.1	0.25	0.5	V/µs	$R_{\rm L}$ = 12 Ω $V_{\rm bb}$ = 13.5 V
4.1.20	slew rate 70% to 30% V _{bb}	-d V / d t_{OFF}	0.1	0.25	0.5	V/µs	$R_{\rm L}$ = 12 Ω $V_{\rm bb}$ = 13.5 V

¹⁾ Not subject to production test, specified by design

Note: Characteristics show the deviation of parameter at the given supply voltage and junction temperature. Typical values show the typical parameters expected from manufacturing.

Data Sheet 14 V1.0, 2004-01-23

Device mounted on PCB (50 mm x 50 mm x 1.5mm epoxy, FR4) with 6 cm 2 copper heatsinking area (one layer, 70 μ m thick) for V_{bb} connection. PCB is vertical without blown air.

 $^{^{3)}\,}$ Not subject to production test, parameters are calculated from $\rm R_{DS(ON)}$ and $\rm R_{th}$



4.2 Protection Functions

The device provides embedded protective functions. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are neither designed for continuous nor repetitive operation.

4.2.1 Over Load Protection

The load current $I_{\rm OUT}$ is limited by the device itself in case of over load or short circuit to ground. There are three steps of current limitation which are selected automatically depending on the voltage $V_{\rm DS}$ across the power DMOS. Please note that the voltage at the OUT pin is $V_{\rm bb}$ - $V_{\rm DS}$. Please refer to following figure for details.

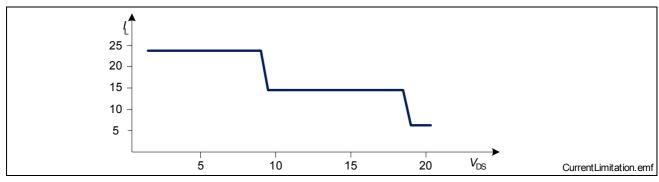


Figure 10 Current Limitation (minimum values)

Current limitation is realized by increasing the resistance of the device which leads to rapid temperature rise inside. A temperature sensor for each channel causes an overheated channel to switch off to prevent destruction. After cooling down with thermal hysteresis, the channel switches on again. Please refer to **Figure 11** for details.

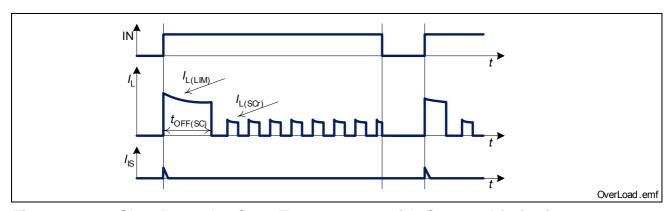


Figure 11 Shut Down by Over Temperature with Current Limitation

In short circuit condition, the load current is initially limited to $I_{L(LIM)}$. After thermal restart, the current limitation level is reduced to $I_{L(SCr)}$. The current limitation level is reset to $I_{L(LIM)}$ by switching off the device (V_{IN} = 0 V).

Data Sheet 15 V1.0, 2004-01-23



4.2.2 Reverse Polarity Protection

In case of reverse polarity, the intrinsic body diode causes power dissipation. Additional power is dissipated by the integrated ground resistor. Use following formula for estimation of total power dissipation $P_{\rm diss(rev)}$ in reverse polarity mode.

$$P_{\rm diss(rev)} = \sum_{\rm all\ channels} (V_{\rm DS(rev)} \cdot I_{\rm L}) + \frac{{V_{\rm bb}}^2}{R_{\rm GND}}$$

The reverse current through the intrinsic body diode has to be limited by the connected load. The current through sense pins IS1 and IS2 has to be limited (please refer to maximum ratings on Page 8). The current through the ground pin (GND) is limited internally by $R_{\rm GND}$. The over-temperature protection is not active during reverse polarity.

4.2.3 Over Voltage Protection

In addition to the output clamp for inductive loads as described in **Section 4.1.3**, there is a clamp mechanism for over voltage protection. Because of the integrated ground resistor, over voltage protection does not require external components.

As shown in **Figure 12**, in case of supply voltages greater than $V_{\rm bb(AZ)}$, the power transistor switches on and the voltage across logic part is clamped. As a result, the internal ground potential rises to $V_{\rm bb}$ - $V_{\rm bb(AZ)}$. Due to the ESD zener diodes, the potential at pin IN1, IN2 and SEN rises almost to that potential, depending on the impedance of the connected circuitry.

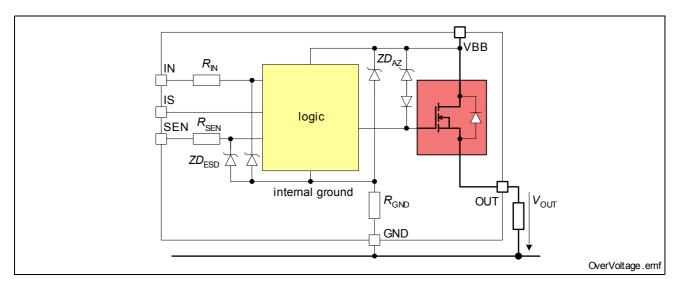


Figure 12 Over Voltage Protection

4.2.4 Loss of Ground Protection

In case of complete loss of the device ground connections, but connected load ground, the BTS 5234L securely changes to or keeps in off state.

Data Sheet 16 V1.0, 2004-01-23



4.2.5 Electrical Characteristics

Unless otherwise specified:

 $V_{
m bb}$ = 9 V to 16 V, $\dot{T}_{
m j}$ = -40 °C to +150 °C , typical values: $V_{
m bb}$ = 13.5 V, $T_{
m j}$ = 25 °C

Pos.	Parameter	Symbol	Lin	Limit Values		Unit	Test Conditions
			min.	typ.	max.		
Over L	oad Protection						
4.2.1	Load current limitation	$I_{L(LIM)}$	23		42	А	V_{DS} = 7 V
		, ,	14		28	Α	V_{DS} = 14 V
4.2.2	Repetitive short circuit current limitation	$I_{L(SCr)}$		6		Α	$T_{\rm j} = T_{\rm j(SC)}^{-1)}$
4.2.3	Initial short circuit shut down time	t _{OFF(SC)}		0.84		ms	$T_{\text{jStart}} = 25 ^{\circ}\text{C}^{-1}$
4.2.4	Thermal shut down temperature	$T_{j(SC)}$	150	170 1)		°C	-
4.2.5	Thermal hysteresis	$\Delta T_{ m j}$		7		K	_1)
Rever	se Battery						
4.2.6	Drain-Source diode voltage (V _{OUT} > V _{bb})	-V _{DS(rev)}			900	mV	I_{L} = -3.5 A V_{bb} = -13.5 V T_{i} = 150°C
4.2.7	Reverse current through GND pin	-I _{GND}		65		mA	$V_{\rm bb}$ = -13.5 V ¹⁾
Groun	d Circuit						
4.2.8	Integrated Resistor in GND line	R_{GND}	115	220	350	Ω	
Over \	/oltage						
4.2.9	Over voltage protection	$V_{bb(AZ)}$	41	47	53	V	$I_{\rm bb}$ = 2 mA
Loss	of GND						
4.2.10	Output leakage current while GND disconnected	$I_{L(GND)}$			1	mA	$I_{IN} = 0, I_{SEN} = 0,$ $I_{IS} = 0,$ $I_{GND} = 0^{(1)(2)}$

¹⁾ Not subject to production test, specified by design

²⁾ no connection at these pins



4.3 Diagnosis

For diagnosis purpose, the BTS 5234L provides an Enhanced IntelliSense signal at pins IS1 and IS2. This means in detail, the current sense signal $I_{\rm IS}$, a proportional signal to the load current (ratio $k_{\rm ILIS} = I_{\rm L} \ / \ I_{\rm IS}$), is provided in ON-state as long as no failure mode occurs. In case of open load in OFF-state, the voltage $V_{\rm IS(fault)}$ is fed to the diagnosis pin.

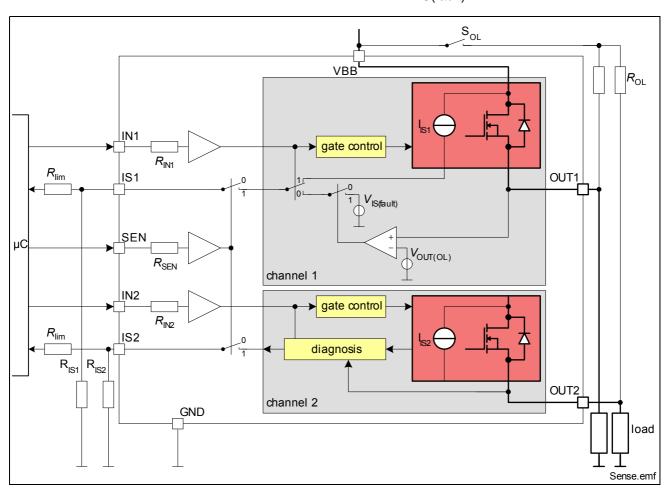


Figure 13 Block Diagram: Diagnosis

Table 1 Truth Table

Operation Mode	Input	Output	Diagnostic Output			
	Level	Level	SEN = H	SEN = L		
Normal Operation (OFF)	L	Z	Z	Z		
Short Circuit to GND		Z	Z	Z		
Over Temperature		Z	Z	Z		
Short Circuit to V _{bb}		V_{bb}	$V_{\rm IS} = V_{\rm IS(fault)}$	Z		
Open Load		< V _{OUT(OL)}	Z	Z		
		$< V_{\text{OUT(OL)}} $ $> V_{\text{OUT(OL)}}$	$V_{IS} = V_{IS(fault)}$	Z		

Data Sheet 18 V1.0, 2004-01-23



Table 1 Truth Table

Operation Mode	Input	Output	Diagnostic Output			
	Level	Level	SEN = H	SEN = L		
Normal Operation (ON)	Н	$\sim V_{ m bb}$	$I_{\rm IS} = I_{\rm L} / k_{\rm ILIS}$	Z		
Current Limitation		$< V_{ m bb}$	Z	Z		
Short Circuit to GND		$<< V_{ m bb}$	Z	Z		
Over Temperature		Z	Z	Z		
Short Circuit to V _{bb}		V_{bb}	$I_{\rm IS} < I_{\rm L} / k_{\rm ILIS}$	Z		
Open Load		$\sim V_{ m bb}$	Z	Z		

L = Low Level, H = High Level, Z = high impedance, potential depends on leakage currents and external circuit

4.3.1 ON-State Diagnosis

The standard diagnosis signal is a current sense signal proportional to the load current. The accuracy of the ratio ($k_{\rm ILIS} = I_{\rm L} / I_{\rm IS}$) depends on the temperature. Please refer to following **Figure 14** for details. Usually a resistor $R_{\rm IS}$ is connected to the current sense pin. It is recommended to use sense resistors $R_{\rm IS} > 500~\Omega$. A typical value is 4.7 k Ω .

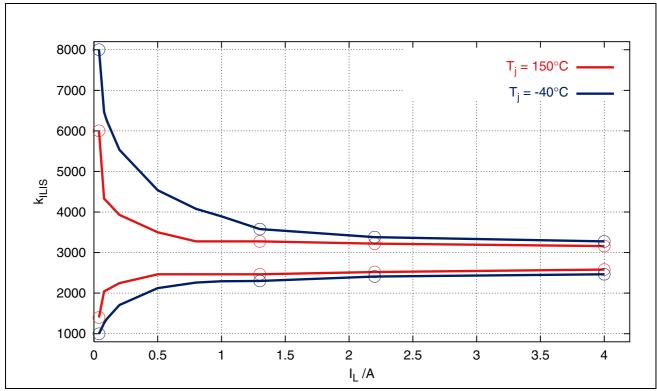


Figure 14 Current sense ratio $k_{\rm ILIS}^{(1)}$

Data Sheet 19 V1.0, 2004-01-23

The curves show the behavior based on characterization data. The marked points are guaranteed in this Data Sheet in Section 4.3.4 (Position 4.3.6).



In case of over current as well as over temperature, the current sense signal is switched off. As a result, one threshold is enough to distinguish between normal and faulty operation. Open load and over load can be differentiated by switching off the channel and using open load detection in off-state.

Details about timings between the diagnosis signal $I_{\rm IS}$ and the output voltage $V_{\rm OUT}$ and load current $I_{\rm L}$ in ON-state can be found in Figure 15.

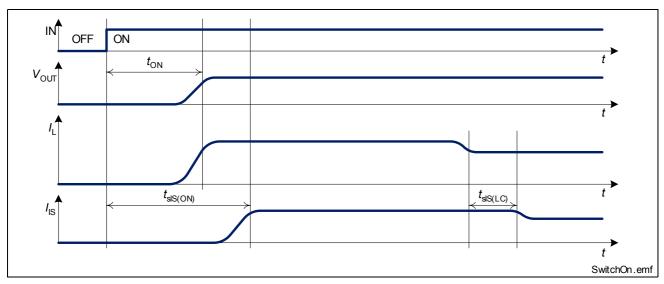


Figure 15 Timing of Diagnosis Signal in ON-state

4.3.2 OFF-State Diagnosis

Details about timings between the diagnosis signal $I_{\rm IS}$ and the output voltage $V_{\rm OUT}$ and load current $I_{\rm L}$ in OFF-state can be found in **Figure 16**.

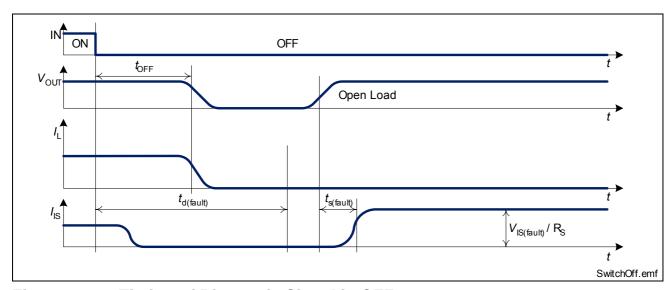


Figure 16 Timing of Diagnosis Signal in OFF-state

Data Sheet 20 V1.0, 2004-01-23



For open load diagnosis in off state an external output pull-up resistor ($R_{\rm OL}$) is recommended. For calculation of the pull-up resistor, just the external leakage current $I_{\rm leakage}$ and the open load threshold voltage $V_{\rm OUT(OL)}$ has to be taken into account.

$$R_{\text{OL}} = \frac{V_{\text{bb(min)}} - V_{\text{OUT(OL,max)}}}{I_{\text{leakage}}}$$

 $I_{
m leakage}$ defines the leakage current in the complete system e.g. caused by humidity. There is no internal leakage current from out to ground at BTS 5234L. $V_{
m bb(min)}$ is the minimum supply voltage at which the open load diagnosis in off state must be ensured.

To reduce the stand-by current of the system, an open load resistor switch (S_{OL}) is recommended.

4.3.3 Sense Enable Function

The diagnosis signals have to be switched on by a high signal at sense enable pin (SEN). See **Figure 17** for details on the timing between SEN pin and diagnosis signal $I_{\rm IS}$. Please note that the diagnosis is disabled, when no signal is provided at pin SEN.

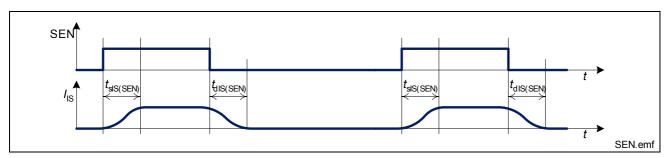


Figure 17 Timing of Sense Enable Signal

The SEN pin circuit is designed equal to the input pin. Please refer to **Figure 5** for details. The resistors R_{lim} are recommended to limit the current through the sense pins IS1 and IS2 in case of reverse polarity and over voltage. Please refer to maximum ratings on Page 8.

The stand-by current of the BTS 5234L is minimized, when both input pins (IN1 and IN2) and the sense enable pin (SEN) are on low level.

Data Sheet 21 V1.0, 2004-01-23



4.3.4 **Electrical Characteristics**

Unless otherwise specified:

 $V_{\rm bb}$ = 9 V to 16 V, $T_{\rm j}$ = -40 °C to +150 °C, $V_{\rm SEN}$ = 5 V, typical values: $V_{\rm bb}$ = 13.5 V, $T_{\rm j}$ = 25 °C

Pos.	Parameter	Symbol	Limit Values			Unit	Test Conditions
			min.	typ.	max.		
Open	Load at OFF-State						
4.3.1	Open load detection threshold voltage	$V_{OUT(OL)}$	1.6	2.8	4.4	V	
4.3.2	Sense signal in case of open load	V _{IS(fault)}	3.5		6.5	V	V_{IN} = 0 V V_{OUT} = V_{bb} I_{IS} = 1 mA
4.3.3	Sense signal current limitation	$I_{IS(LIM)}$	2			mA	V_{IN} = 0 V V_{OUT} = V_{bb}
4.3.4	Sense signal invalid after negative input slope	t _{d(fault)}			1.2	ms	V_{IN} = 5 V to 0 V V_{OUT} = V_{bb}
4.3.5	Fault signal settling time	t _{s(fault)}			200	μs	V_{IN} = 0 V V_{OUT} = 0 V to V_{OUT} > V_{OUT} = 1 mA
Load	Current Sense ON-Stat	te					
4.3.6	Current sense ratio	k_{ILIS}					V_{IN} = 5 V
	I_{L} = 40 mA I_{L} = 1.3 A I_{L} = 2.2 A I_{L} = 4.0 A		1000 2300 2410 2465	4035 3050 2920 2850	8000 3580 3380 3275		<i>T</i> _j = -40 °C
	I_{L} = 40 mA I_{L} = 1.3 A I_{L} = 2.2 A I_{L} = 4.0 A		1400 2465 2520 2580	3410 2920 2875 2870	6000 3275 3220 3160		<i>T</i> _j = 150 °C
4.3.7	Current sense voltage limitation	$V_{IS(LIM)}$	5.0	6.2	7.5	V	$I_{IS} = 0.5 \text{ mA}$ $I_{L} = 3.5 \text{ A}$
4.3.8	Current sense leakage/offset current	$I_{IS(LH)}$			5	μΑ	$V_{\text{IN}} = 5 \text{ V}$ $I_{\text{L}} = 0 \text{ A}$

Data Sheet 22 V1.0, 2004-01-23



Unless otherwise specified:

 $V_{\rm bb}$ = 9 V to 16 V, $T_{\rm j}$ = -40 °C to +150 °C, $V_{\rm SEN}$ = 5 V, typical values: $V_{\rm bb}$ = 13.5 V, $T_{\rm j}$ = 25 °C

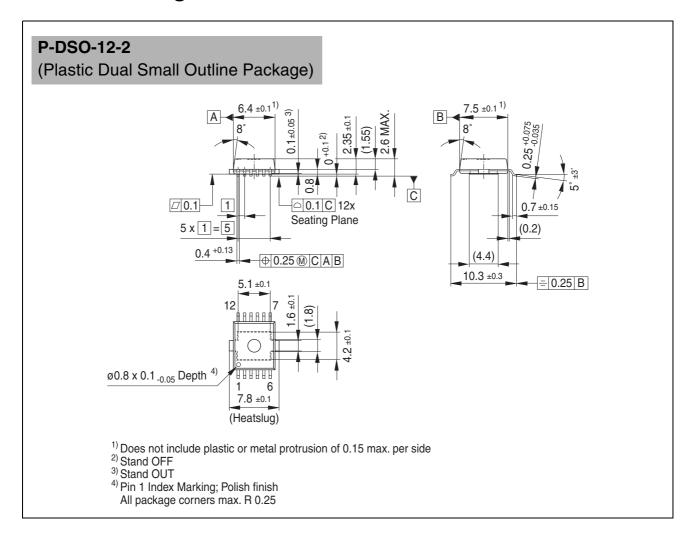
Pos.	Parameter	Symbol	Limit Values			Unit	Test Conditions
			min.	typ.	max.		
4.3.9	Current sense leakage, while diagnosis disabled	$I_{IS(dis)}$			2	μΑ	$V_{\text{SEN}} = 0 \text{ V}$ $I_{\text{L}} = 3.5 \text{ A}$
4.3.10	Current sense settling time to $I_{\rm IS}$ static $\pm 10\%$ after positive input slope	$t_{\sf SIS}({\sf ON})$			300	μs	$V_{\rm IN}$ = 0 V to 5 V $I_{\rm L}$ = 3.5 A
4.3.11	Current sense settling time to $I_{\rm IS}$ static $\pm 10\%$ after change of load current	t _{SIS(LC)}			50	μs	V_{IN} = 5 V I_{L} = 1.3 A to 2.2 A 1)
Sense	Enable						
4.3.12	Input resistance	R _{SEN}	1.8	3.5	5.5	kΩ	
4.3.13	L-input level	$V_{SEN(L)}$	-0.3		1.0	V	
4.3.14	H-input level	$V_{SEN(H)}$	2.5		5.7	V	
4.3.15	L-input current	$I_{SEN(L)}$	3	18	75	μΑ	$V_{SEN} = 0.4 V$
4.3.16	H-input current	I _{SEN(H)}	10	38	75	μΑ	$V_{SEN} = 5 \; V$
4.3.17	Current sense settling time	$t_{\sf sIS(SEN)}$		3	25	μs	$\begin{aligned} V_{\text{SEN}} &= 0 \text{ V to 5 V} \\ V_{\text{IN}} &= 0 \text{ V} \\ V_{\text{OUT}} &> V_{\text{OUT(OL)}} \end{aligned}$
4.3.18	Current sense deactivation time	t _{dIS(SEN)}			25	μs	$V_{\rm SEN}$ = 5 V to 0 V $I_{\rm L}$ = 3.5 A $R_{\rm S}$ = 5 k Ω ¹⁾

¹⁾ Not subject to production test, specified by design



Package Outlines BTS 5234L

5 Package Outlines BTS 5234L



You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": http://www.infineon.com/products.

SMD = Surface Mounted Device

Dimensions in mm

Data Sheet 24 V1.0, 2004-01-23



Smart High-Side Power Switch BTS 5234L

Revision History

6 Revision History

Version	Date	Changes
V1.0	04-01-23	initial version